Schottky Barrier Diode

NSR0230P2

These Schottky barrier diodes are designed for high-speed switching applications, circuit protection, and voltage clamping. Extremely low forward voltage reduces conduction loss. Miniature surface mount package is excellent for hand-held and portable applications where space is limited.

Features

- Extremely Fast Switching Speed
- Extremely Low Forward Voltage 0.325 V (max) @ I_F = 10 mA
- Low Reverse Current
- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Reverse Voltage	V _R	30	Vdc
Forward Current DC	I _F	200	mA
Forward Current Surge Peak (60 Hz, 1 cycle)	I _{FSM}	1.0	Α
ESD Rating: Class 3B per Human Body Model Class C per Machine Model			

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Max	Unit
Total Device Dissipation FR-5 Board, (Note 1) T _A = 25°C	P _D	200	mW
Derate above 25°C		2.0	mW/°C
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	600	°C/W
Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +125	°C

1. FR-5 Minimum Pad.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

Characteristic	Symbol	Min	Тур	Max	Unit
Reverse Leakage (V _R = 10 V)	I _R	-	-	10	μА
Forward Voltage (I _F = 10 mA) (I _F = 200 mA)	V _F	1 1	1 1	0.325 0.500	Vdc

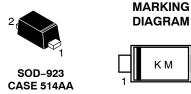


ON Semiconductor®

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30 V SCHOTTKY BARRIER DIODE





K = Specific Device Code*
 (Character is rotated 270° clockwise)
 M = Month Code

ORDERING INFORMATION

Device	Package	Shipping†
NSR0230P2T5G	SOD-923 (Pb-Free)	2 mm Pitch 8000/Tape & Reel
NSVR0230P2T5G	SOD-923 (Pb-Free)	2 mm Pitch 8000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NSR0230P2

TYPICAL CHARACTERISTICS

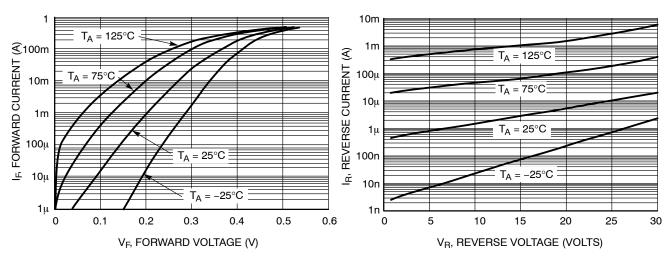


Figure 1. Forward Characteristics

Figure 2. Reverse Characteristics

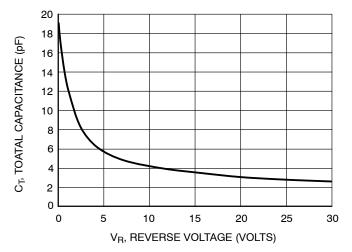


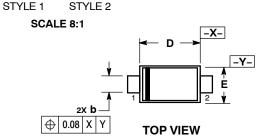
Figure 3. Total Capacitance

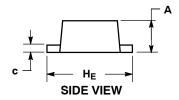


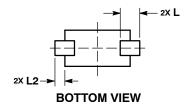


SOD-923 CASE 514AB-01 ISSUE C

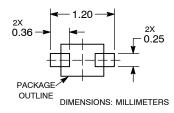
DATE 11 MAR 2011







SOLDERING FOOTPRINT*



See Application Note AND8455/D for more mounting details

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NOTES:

- NOTES:

 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

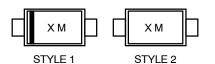
 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.

 4. DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS.

	MIL	LIMETE	ERS	INCHES		
DIM	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.34	0.37	0.40	0.013	0.015	0.016
b	0.15	0.20	0.25	0.006	0.008	0.010
С	0.07	0.12	0.17	0.003	0.005	0.007
D	0.75	0.80	0.85	0.030	0.031	0.033
Е	0.55	0.60	0.65	0.022	0.024	0.026
HE	0.95	1.00	1.05	0.037	0.039	0.041
L	().19 REI	F	0.007 REF		
L2	0.05	0.10	0.15	0.002	0.004	0.006

GENERIC MARKING DIAGRAM*



Χ = Specific Device Code = Date Code M

*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " ■", may or may not be present.

STYLE 2: NO POLARITY STYLE 1: PIN 1. CATHODE (POLARITY BAND) 2. ANODE

	DOCUMENT NUMBER:	98AON23284D	Е
	STATUS:	ON SEMICONDUCTOR STANDARD	a V
Г	NEW STANDARD:		"
Г	DESCRIPTION:	SOD-923, 1.0X0.6X0.37, MAX HEIGHT 0.	40

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ISSUE	REVISION	DATE
0	RELEASED FOR PRODUCTION. REQ. BY J. DAUGHERTY.	29 AUG 2006
Α	CHANGED DIMENSION A VALUES. REQ. BY D. TRUHITTE.	23 JAN 2007
В	B CREATED CATHODE AND NON-CATHODE BAND VERSIONS. REQ. BY J. DAUGHERTY.	
С	ADDED BOTTOM VIEW AND DIMENSION L2. MODIFIED SOLDER FOOTPRINT. REQ. BY D. TRUHITTE.	11 MAR 2011

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